

Realtek Semiconductor Corp.

No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan

Confidential Letter

Date: 2025/6/3

Federal Communications Commission
Authorization and Evaluation Division
7435 Oakland Mills Road
Columbia MD 21046
USA
Subject: Request for Confidentiality

FCC ID : TX2-RTL8852CE

To Whom It May Concern:

Long Term Confidentiality

Pursuant to Sections 0.457 and 0.459 of the Commission's Rules, we hereby respectfully request confidential treatment of information accompanying this application as outlined below:

- Block Diagrams
- Schematics
- Operational Description

The above materials contain trade secrets and proprietary information not customarily released to the public. The public disclosure of these matters might be harmful to the Applicant and provide unjustified benefits to its competitors.

We understand that pursuant to Rule 0.457, disclosure of this Application and all accompanying documentation will not be made before the date of the Grant for this application.

Respectfully,

Applicant's company name : Realtek Semiconductor Corp.

Applicant's company address : No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan

Signature :



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